

1A LOW DROPOUT LINEAR REGULATOR

ZSU1117B-XXX

FEATURES

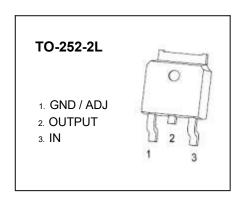
Low Dropout Voltage: 1.3V at 1A Output Current

Trimmed Current Limit

On-Chip Thermal Shutdown

Three-Terminal Adjustable or Fixed 1.8V, 2.5V, 3.3V, 5V

Operation Junction Temperature: -40 to 125°C



GENERAL DESCRIPTION

The ZSU1117B-XXX is a series of low dropout three-terminal regulators with a dropout of 1.3V at 1A output current.

The ZSU1117B-XXX series provides current limiting and thermal shutdown. Its circuit includes a trimmed bandage, reference to assure output voltage accuracy to be within 1.5%. Current limit is trimmed to ensure specified, output current and controlled short-circuit current. On-chip thermal shutdown provides protection against any combination of overload and ambient temperature that would create excessive junction temperature.

The ZSU1117B-XXX has an adjustable version, that can provide the output voltage from 1.25V to 12V with only 2 external resistors.

APPLICATIONS

PC Motherboard

LCD Monitor

Graphic Card

DVD-Video Player

NIC/Switch

Telecom Modem

ADSL Modem

Printer and other peripheral Equipment

MARKING



"U1117B": Device serial number.

"X.X": Output voltage, for example, if $V_{OUT} = 3.0V$, "X.X" = 3.0.

"YYYY": Code composed of four uppercase letters, indicates weekly record information of production.

MAXIMUM RATINGS

ORDERING INFORMATION

Package	Operating Junction Temperature Range	Part NO.
		ZSU1117B-ADJ
		ZSU1117B-1.8
TO-252-2L	-40 to 125℃	ZSU1117B-2.5
		ZSU1117B-3.3
		ZSU1117B-5.0

ABOSLUTE MAXIMUM RATINGS

(T_A = 25°C, unless otherwise specified)

Parameter	Symbol	Value	Unit	
Input Voltage	Vi	20	V	
Thermal Resistance from Junction to Ambient	Reja	80	°C/W	
Maximum Junction Temperature	T _{J Max}	-40~+150	${\mathfrak C}$	
Storage Temperature	T _{stg}	-40~+150	${\mathfrak C}$	
Lead Temperature (Soldering, 10sec.)	TL	260°C,10s		
ESD Voltage (Machine Model)	V _{ESD}	250	V	

Note: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Value	Unit
Input Voltage	Vi	15	V
Operating Junction Temperature	TJ	-40~+125	${\mathbb C}$
Operating Ambient Temperature	TA	-40~+85	$^{\circ}$

ELECTRICAL CHARACTERISTICS

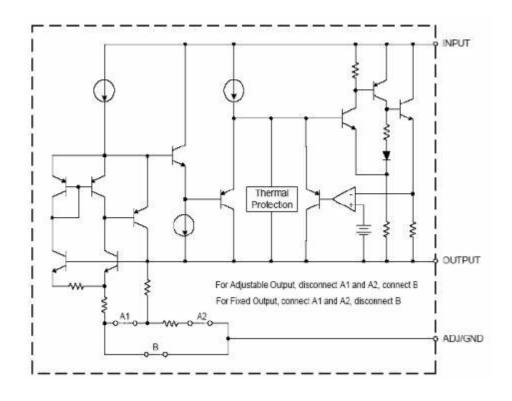
$V_{IN} \leq 10V$, $T_J=25$ °C unless otherwise specified.

Parameter	Symbol	Part No.	Test Conditions	Min	Тур	Max	Unit	
Deference Voltage	teference Voltage V _{IROC} ZSU1117B-ADJ		I _{OUT} =10mA, V _{IN} =3.23V	1.231	1.250	1.269	V	
Reference Voltage V _{IROC} ZSU1117B-		2501117B-ADJ	10mA≤I _{OUT} ≤1A, 2.75V≤V _{IN} -V _{OUT} ≤13.25V	1.225	1.250	1.275	v	
		ZSU1117B-1.8	I _{OUT} =10mA, V _{IN} =3.8V	1.773	1.8	1.827	.,	
			10mA≤I _{OUT} ≤1A, 3.3V≤V _{IN} ≤12V	1.764	1.8	1.836	V	
		7011444770.05	I _{OUT} =10mA, V _{IN} =4.5V	2.463	2.5	2.538	.,	
		ZSU1117B-2.5	10mA≤I _{OUT} ≤1A, 4V≤V _{IN} ≤12V	2.450	2.5	2.550	V	
Output Voltage	Vo	7011444770.00	I _{OUT} =10mA, V _{IN} =5.3V	3.251	3.3	3.350		
		ZSU1117B-3.3	10mA≤I _{OUT} ≤1A, 4.8V≤V _{IN} ≤12V	3.234	3.3	3.366	V	
		701144477 7.0	I _{OUT} =10mA, V _{IN} =7.0V	4.925	5.0	5.075	.,	
		ZSU1117B-5.0	10mA≤I _{OUT} ≤1A, 6.5V≤V _{IN} ≤12V	4.9	5.0	5.1	V	
		ZSU1117B-ADJ	I _{OUT} =10mA, 1.5V≤V _{IN} -V _{OUT} ≤12V			0.2	%	
		ZSU1117B-1.8	I _{OUT} =10mA, 1.5V≤V _{IN} -V _{OUT} ≤10.2V			7		
Line Regulation	LNR	ZSU1117B-2.5	I _{OUT} =10mA, 1.5V≤V _{IN} -V _{OUT} ≤9.5V			7		
		ZSU1117B-3.3	I _{OUT} =10mA, 1.5V≤V _{IN} -V _{OUT} ≤8.7V			7	mV	
		ZSU1117B-5.0	I _{OUT} =10mA, 1.5V≤V _{IN} -V _{OUT} ≤7V			10	ı	
	LDR	ZSU1117B-ADJ				0.4	%	
		ZSU1117B-1.8				7.2	mV	
Load Regulation		ZSU1117B-2.5	VI _N -V _{OUT} =1.5V, 10mA≤I _{OUT} ≤1A			10		
		ZSU1117B-3.3				13.2		
		ZSU1117B-5.0				20		
Dropout Voltage	V _D		ΔV _{REF} =1%, I _{OUT} =1.0A			1.3	V	
Adjust Pin Current	I _{ADJ}	ZSU1117B-ADJ	V _{IN} = 5V 10mA≤I _{OUT} ≤0.8A		60	120	μA	
Adjust Pin Current Change	ΔI_{ADJ}	ZSU1117B-ADJ	2.75V≤V _{IN} -V _{OUT} ≤12V (ADJ only)		1.7	5	μA	
Minimum Load Current	l.	ZSU1117B-ADJ	V _{IN} = 5V, V _{ADJ} = 0V		5	7	mA	
Quiescent Current	l _q		V _{IN} = 12V (ADJ except)		5	10	mA	
Ripple Rejection	PSRR		f=10kHz, C _{OUT} =22μFTantalum, V _{IN} -V _{OUT} =3V, I _{OUT} =1A	60	70		dB	
Temperature Stability					0.5		%	
Long-Term Stability			T _A =125℃ , 1000hrs		0.3		%	
RMS Output Noise (% of VOUT)			T _A =25°C , 10Hz≤f ≤10kHz		0.003		%	
Thermal Shutdown Hysteresis					25		°C	

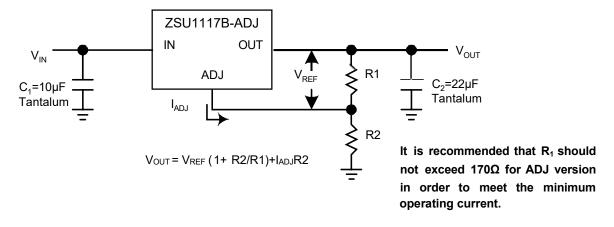
^{*} With package soldering to copper area over backside ground plane or internal power plane $R_{\theta JA}$ can vary from 46 °C/W to >90°C/W depending on mounting technique and the size of the copper area

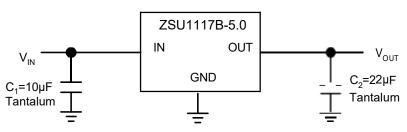
FUNCTIONAL BLOCK and TYPICAL APPLICATION

FUNCTIONAL BLOCK DIAGRAM



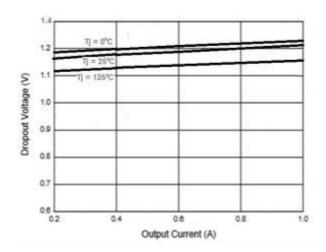
TYPICAL APPLICATION CIRCUIT



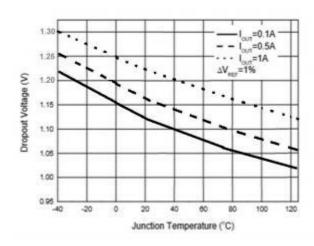


TYPICAL PERFORMANCE CHARACTERISTICS

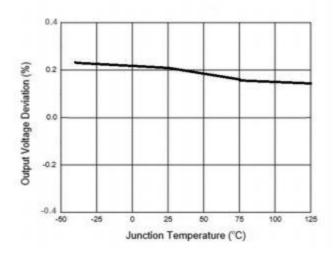
Dropout Voltage vs. Output Current



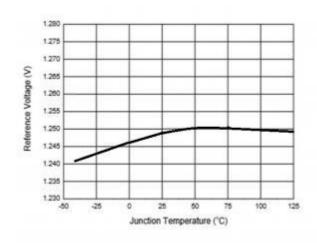
Dropout Voltage vs. Junction Temperature



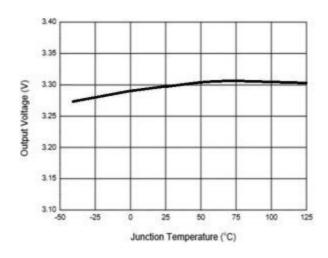
Load Regulation vs. Junction Temperature



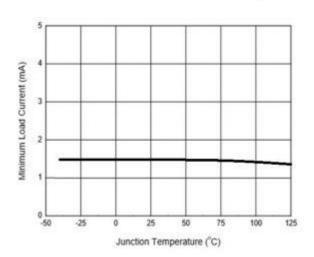
Reference Voltage vs. Junction Temperature



Output Voltage vs. Junction Temperature

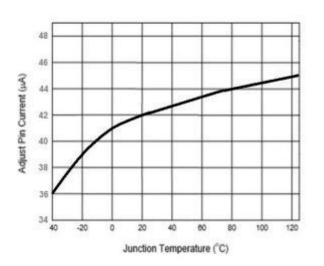


Minimum Load Current vs. Junction Temperature

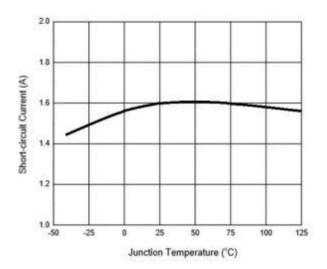


TYPICAL PERFORMANCE CHARACTERISTICS

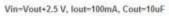
Adjust Pin Current vs. Junction Temperature

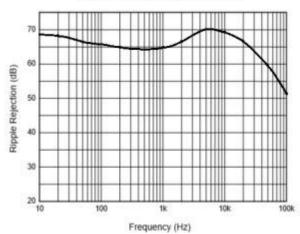


Short-circuit Current vs. Junction Temperature

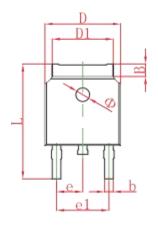


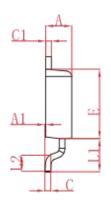
Ripple Rejection vs. Frequency

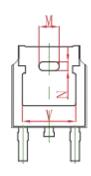




TO-252(4R)-2L Package Outline Dimensions

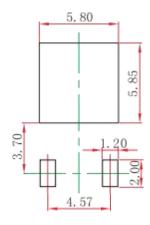






0	Dimensions I	n Millimeters	Dimensions In Inches			
Symbol	Min.	Max.	Min.	Max.		
Α	2.200	2.380	0.087	0.094		
A1	0.000	0.100	0.000	0.004		
В	0.800	1.400	0.031	0.055		
b	0.710	0.810	0.028	0.032		
С	0.460	0.560	0.018	0.022		
c1	0.460	0.560	0.018	0.022		
D	6.500	6.700	0.256	0.264		
D1	5.130	5.460	0.202	0.215		
Е	6.000	6.200	0.236	0.244		
е	2.286	TYP.	0.090	TYP.		
e1	4.327	4.727	0.170	0.186		
M	1.778	BREF.	0.070	REF.		
N	0.762	REF.	0.018	BREF.		
L	9.800	10.400	0.386	0.409		
L1	2.9F	.9REF. 0.114REF.		REF.		
L2	1.400	1.700	0.055	0.067		
V	4.830	REF.	0.190 REF.			
Ф	1.100	1.300	0.043	0.051		

TO-252(4R)-2L Suggested Pad Layout

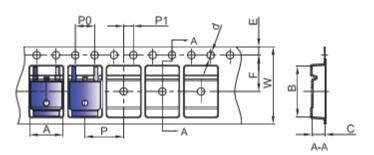


NOTE:

- 1. Controlling dimension: in millimeters.
- 2. General tolerance: ±0.05mm.
- 3. The pad layout is for reference purposes only.

To-252(4R)-2L Tape and Reel

TO-252 Embossed Carrier Tape

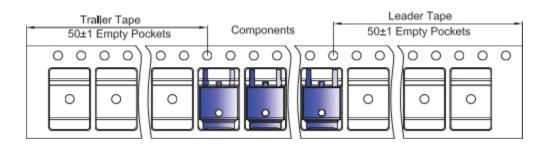


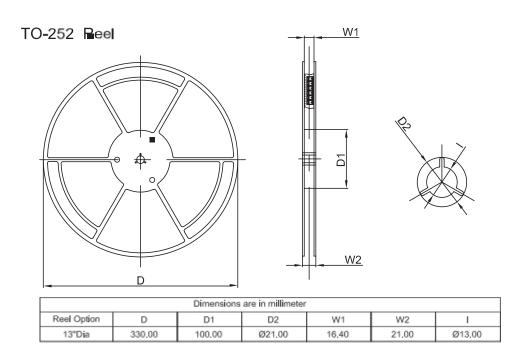
Packaging Description:

TO-252 parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 25,00 units per 13" or 33,0 cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

Dimensions are in millimeter										
Pkg type A B C d E F P0 P P1								W		
TO-252	6.90	10.50	2.70	Ø1.55	1.75	7.50	4.00	8.00	2.00	16.00

TO-252 Tape Leader and Trailer





REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
2,500 pcs	13Inch	2,500 pcs	340×336×29	25,000 pcs	353×346×365	

DISCLAIMER

IMPORTANT NOTICE, PLEASE READ CAREFULLY

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